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September 2015

J211 / MMBFJ211
N-Channel RF Amplifier

Description

This device is designed for HF/VHF mixer/amplifier and applications where process 50 is not adequate. Sufficient gain and low-noise for sensitive receivers. Sourced from process 90.

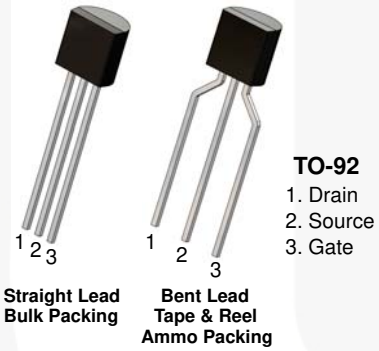

Figure 1. J211 Device Package

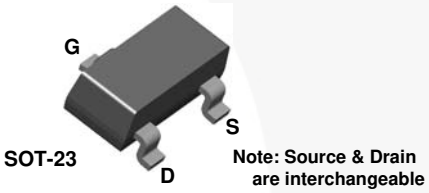

Figure 2. MMBFJ211 Device Package

Ordering Information

Part Number	Top Mark	Package	Packing Method
J211_D74Z	J211	TO-92 3L	Ammo
MMBFJ211	62W	SOT-23 3L	Tape and Reel

Absolute Maximum Ratings[1], [2]

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
V_{DG}	Drain-Gate Voltage	25	V
V_{GS}	Gate-Source Voltage	-25	V
I_{GF}	Forward Gate Current	10	mA
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C

Notes:

1. These ratings are based on a maximum junction temperature of 150°C.
2. These are steady-state limits. Fairchild Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

Thermal Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Max.		Unit
		J211[3]	MMBFJ211[3]	
P_D	Total Device Dissipation	350	225	mW
	Derate Above 25°C	2.8	1.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	125		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	357	556	°C/W

Note:

3. Device mounted on FR-4 PCB 36mm × 18mm × 1.5mm; mounting pad for the collector lead minimum 6cm^2.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Max.	Unit
Off Characteristics					
$V_{(BR)GSS}$	Gate-Source Breakdown Voltage	I_G = 1.0 µA, V_{DS} = 0	-25		V
I_{GSS}	Gate Reverse Current	V_{GS} = 15 V, V_{DS} = 0		-100	pA
V_{GS}(off)	Gate-Source Cut-Off Voltage	V_{DS} = 15 V, I_D = 1.0 nA	-2.5	-4.5	V
On Characteristics					
I_{DSS}	Zero-Gate Voltage Drain Current[4]	V_{DS} = 15 V, V_{GS} = 0	7.0	20	mA
Small Signal Characteristics					
g_{fs}	Common Source Forward Transconductance	V_{DS} = 15 V, V_{GS} = 0, f = 1.0 kHz	7000	12000	µmhos
g_{oss}	Common Source Output Conductance	V_{DS} = 15 V, V_{GS} = 0, f = 1.0 kHz		200	µmhos

Note:

4. Pulse test: pulse width ≤ 300 µs

Typical Performance Characteristics

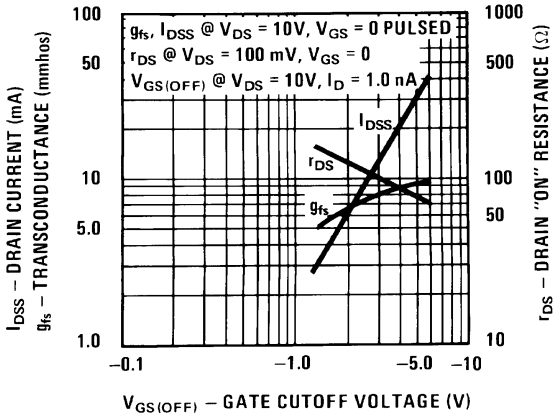

Figure 3. Parameter Interactions

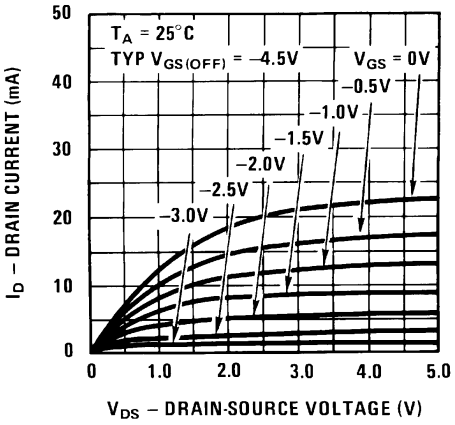

Figure 4. Common Drain-Source

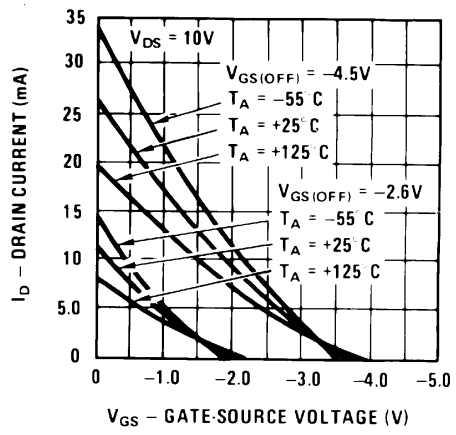

Figure 5. Transfer Characteristics

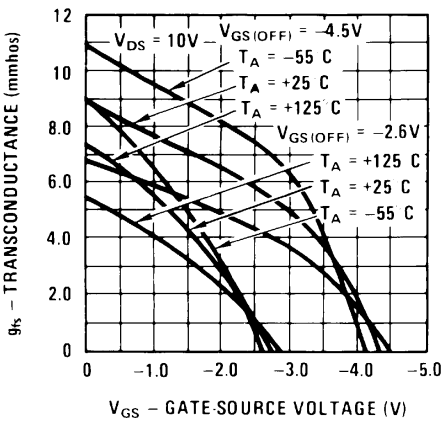

Figure 6. Transfer Characteristics

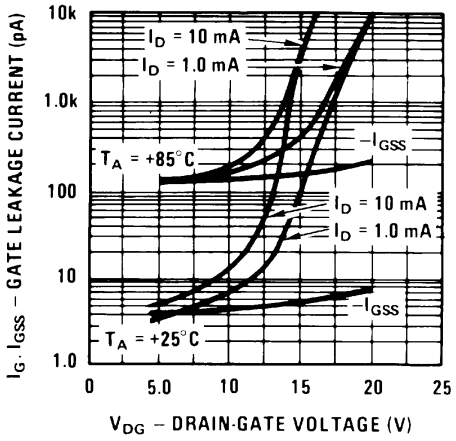

Figure 7. Leakage Current vs. Voltage

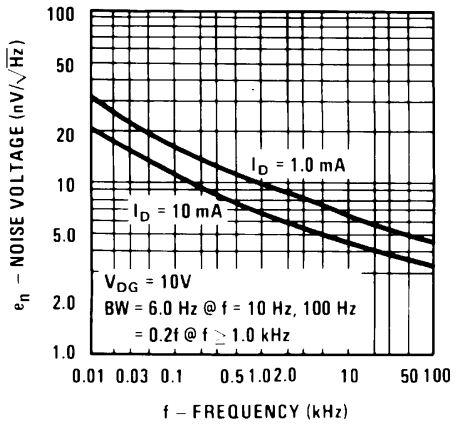

Figure 8. Noise Voltage vs. Frequency

Typical Performance Characteristics (Continued)

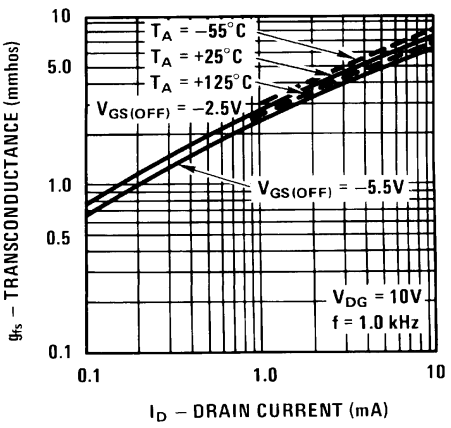

Figure 9. Transconductance vs. Drain Current

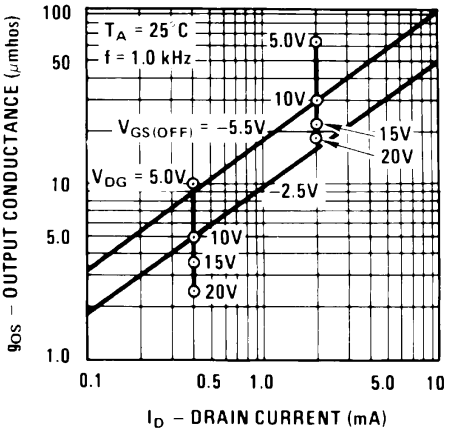

Figure 10. Output Conductance vs. Drain Current

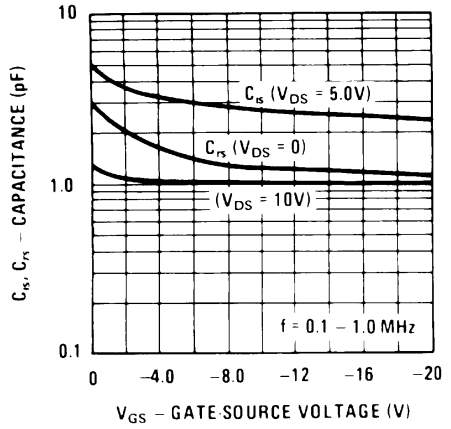

Figure 11. Capacitance vs. Voltage

Common Source Characteristics

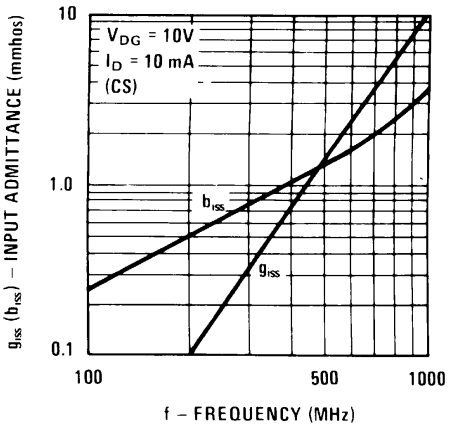

Figure 12. Input Admittance

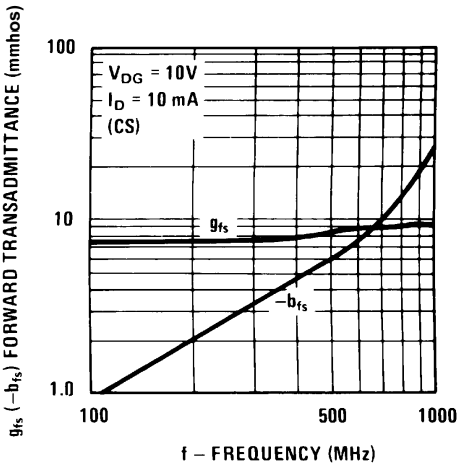

Figure 13. Forward Transadmittance

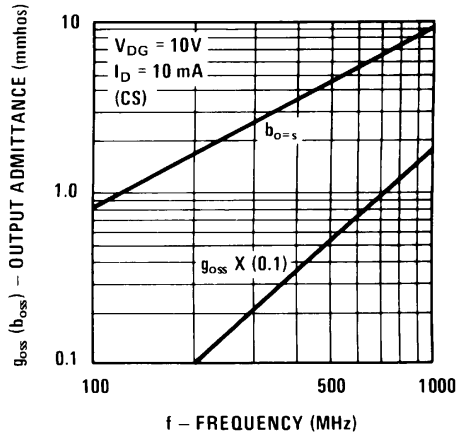

Figure 14. Output Admittance

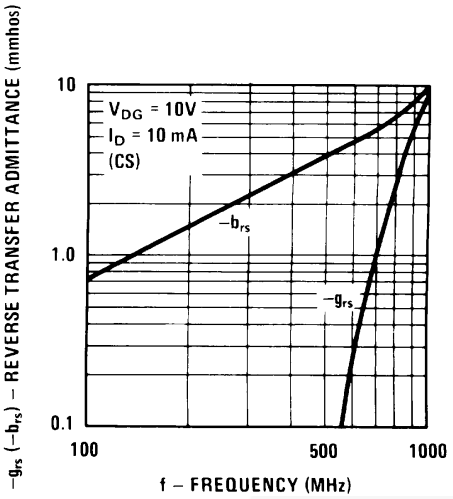

Figure 15. Reverse Transadmittance

Common Gate Characteristics

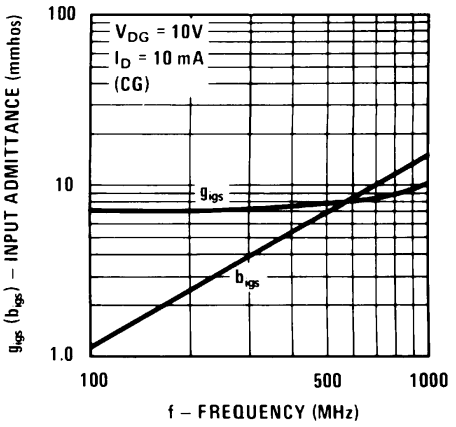

Figure 16. Input Admittance

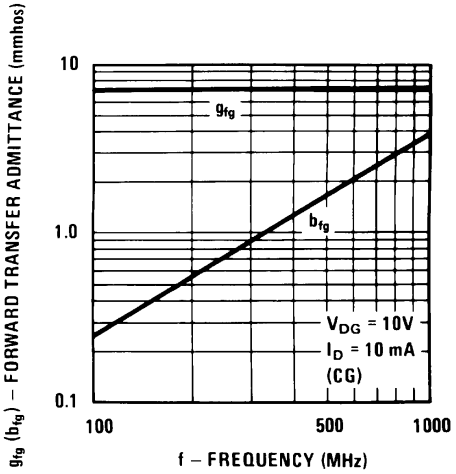

Figure 17. Forward Transadmittance

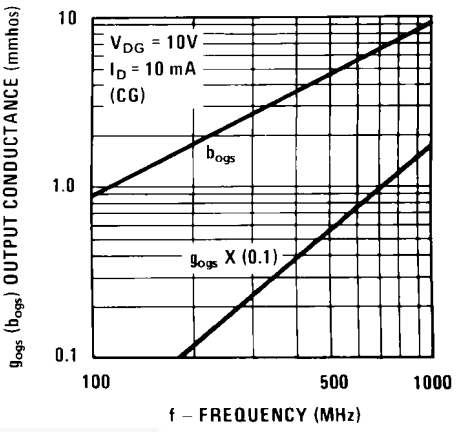

Figure 18. Output Admittance

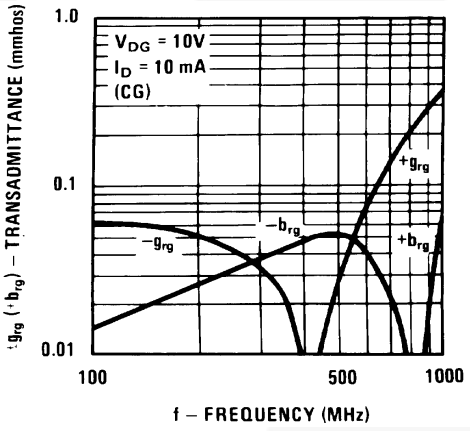

Figure 19. Reverse Transadmittance

Physical Dimensions

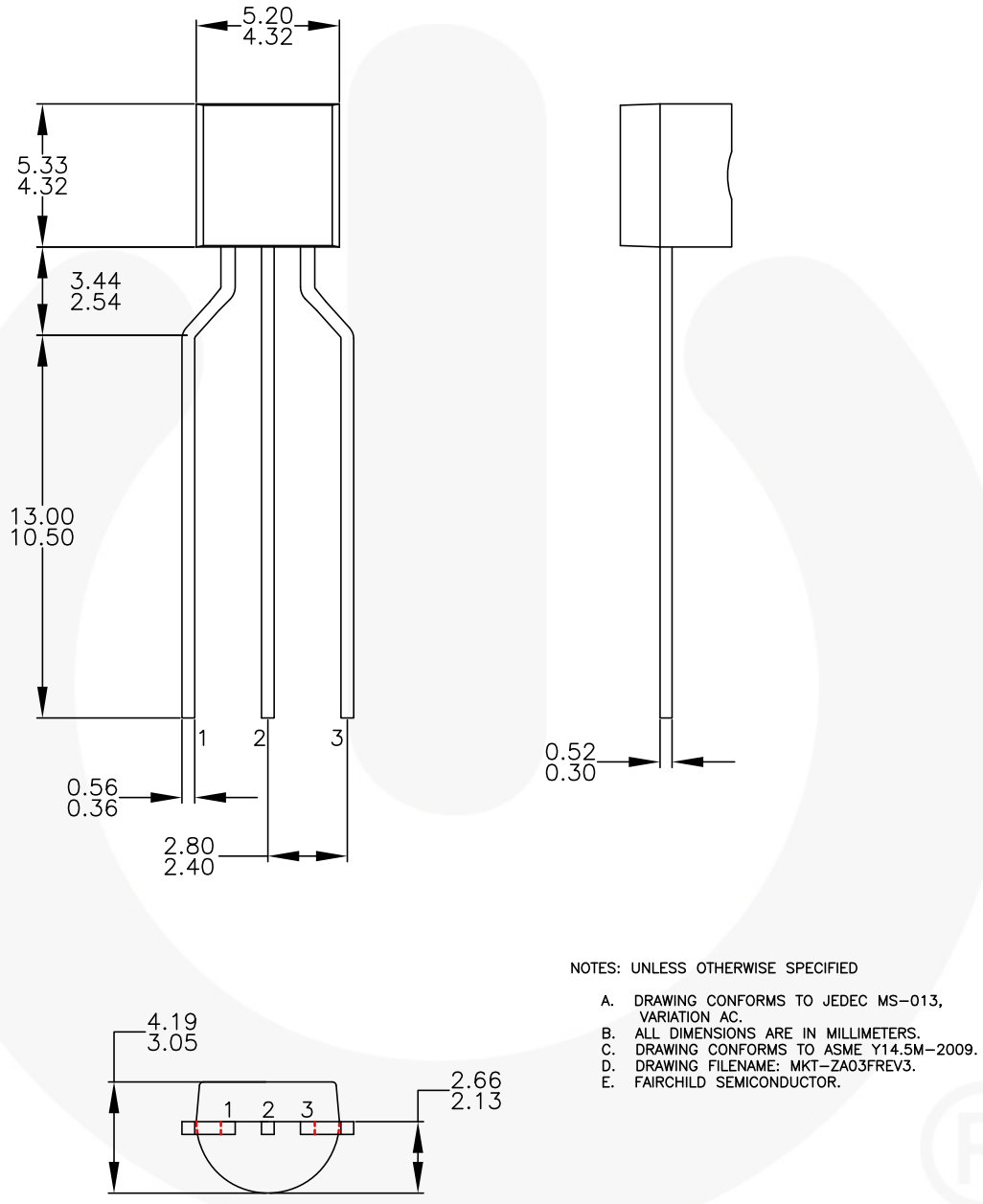

Figure 20. 3-Lead, TO-92, Molded, 0.2 In Line Spacing Lead Form

Physical Dimensions (Continued)

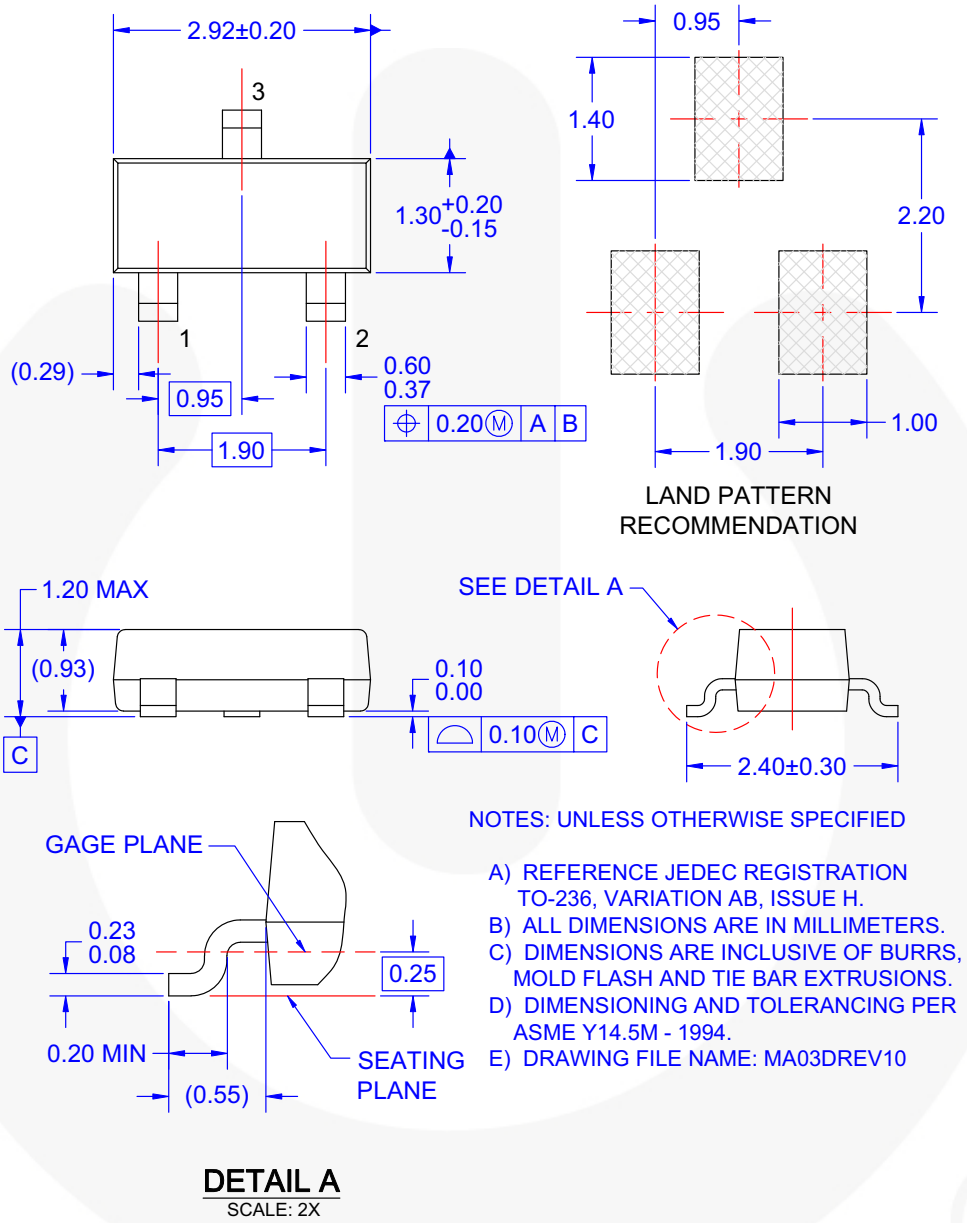

Figure 21. 3-LEAD, SOT23, JEDEC TO-236, LOW PROFILE

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